

INDIVIDUAL SPECIFICATION SHEET

Product Name: 1206 Slow Blow SMD Fuses

Part Number: :F12T30

Revision: B



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Rev.	Effective Date	Changed Contents
A	2021-1-5	New Release
B	2021-3-10	Update Spedfications

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Description

F12T Series are the fuses set the industry standard for performance, reliability and quality. The solder-free design provides excellent on-off and temperature cycling characteristics during use and also makes our SMD fuses more heat and shock tolerant than typical subminiature fuses.

Electrical Characteristics					
Rated Current	1.0In	2.5In	3.0In	3.5In	10.0In
30A	4 hour min.	-	-	5 sec max.	0.2ms – 10ms

Features

- High inrush current withstanding capability
- AEC-Q200 Automotive Grade Certified
- Compatible with reflow and wave solder
- Ceramic and glass construction
- Excellent environmental integrity
- One time positive disconnect
- Lead Free and Halogen free material

Specifications

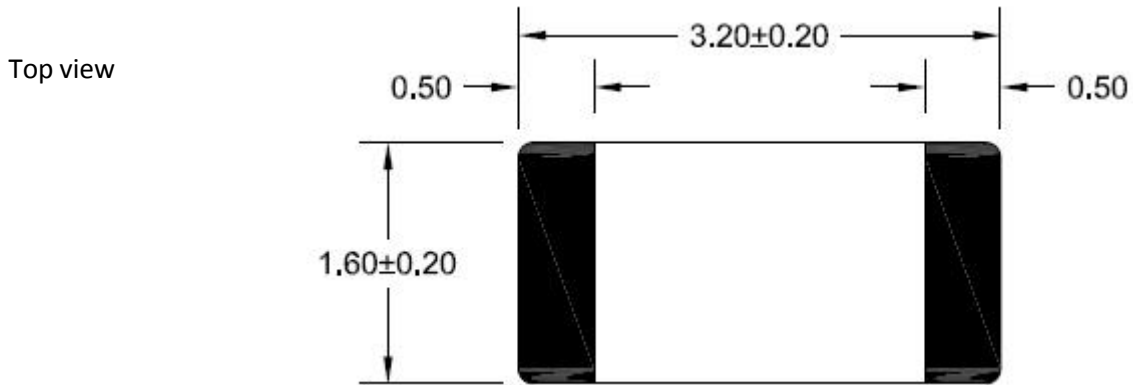
Specification							
Part No.	Rated	Rated	Breaking Capacity (A) ¹	Typical Cold Resistance (mOhms) ²	Typical Voltage Drop (mV)	Typical Pre-Arcing I ² t (A ² Sec) ³	Alpha Mark
	Voltage	Current (A)					
	DC						
F12T30	32V	30	150A@32Vdc	1.3	90	100	Z

1. DC Interrupting Rating (Measured at rated voltage, time constant of less than 50 microseconds, battery source)
2. DC Cold Resistance are measured at <10% of rated current in ambient temperature of 25°C
3. Typical Pre-arcing I²t are measured at 10In Current

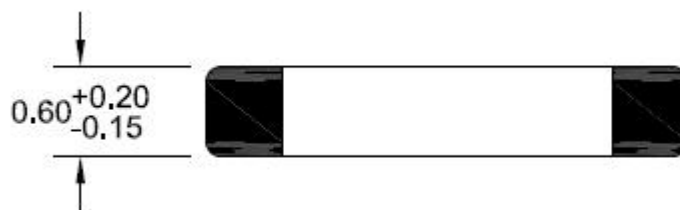
Choice fuse for surge application (USB charger etc.), make sure the I²t of fuse is 4 times than surge. Specifications are subject to change without notice. Application testing is strongly recommended.

Dimension

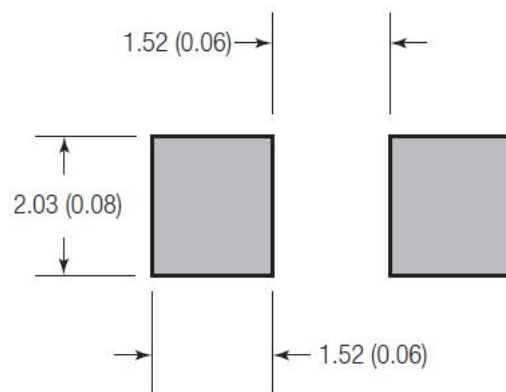
Drawing not to scale (Unit: mm)



Side view

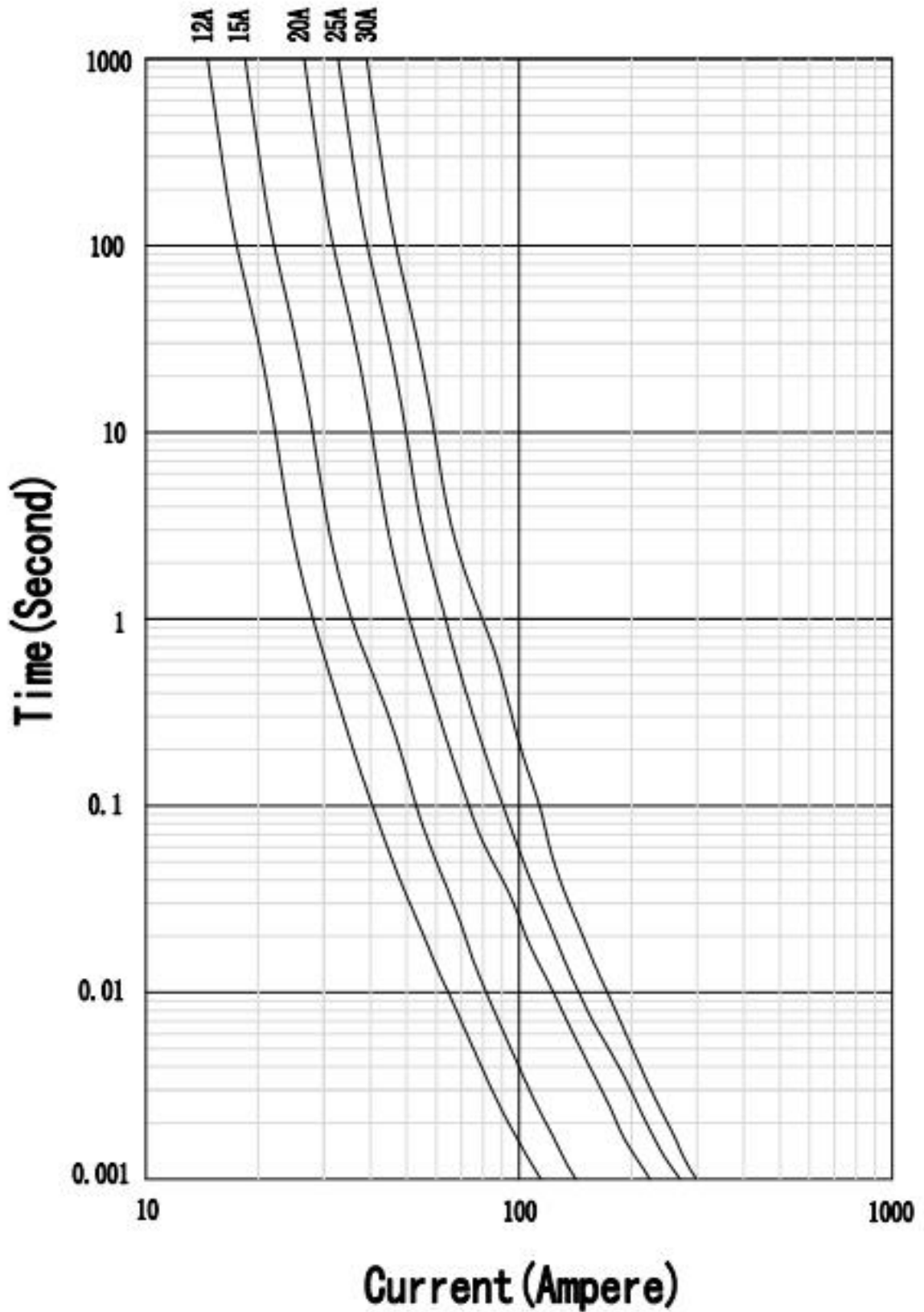


Recommended land pattern



Unit: mm(inch)

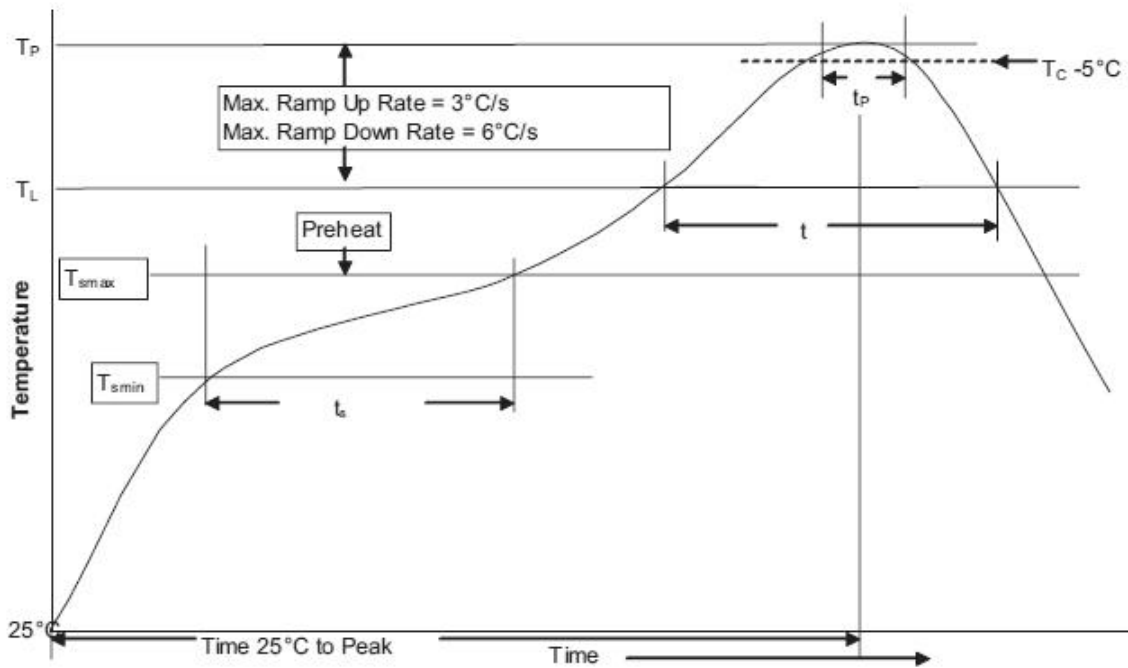
Time Current Curve



Soldering method

- Wave solder
 - Reservoir temperature: 260°C
 - Time in reservoir: 10 seconds maximum
- Infrared reflow
 - Temperature: 260°C
 - Time: 30 seconds maximum

Solder reflow profile

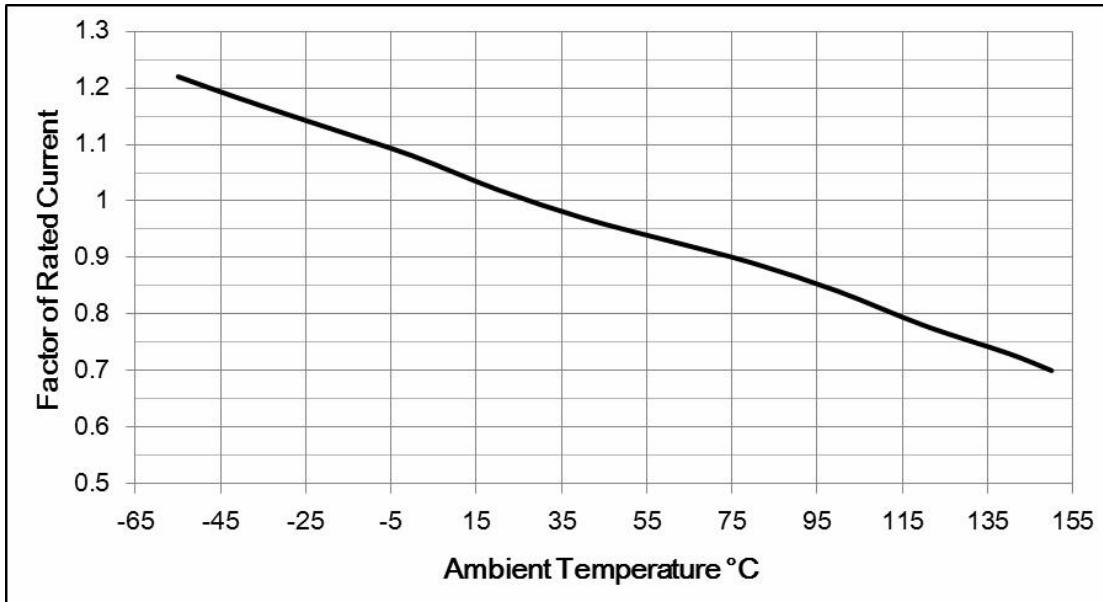


Profile Feature		Lead(Pb) free solder
Preheat and soak	• Temperature min. (T_{smin})	150°C
	• Temperature max. (T_{smax})	200°C
	• Time (T_{smin} to T_{smax}) (t_s)	60 - 120 Seconds
Average ramp up rate T_{smax} to T_p		3°C / Second Max.
Liquidous temperature (T_L)		217°C
Time at liquidous (t_L)		60 - 150 Seconds
Peak package body temperature (T_P)		260°C
Time (t_p) within 5°C of the specified classification temperature (T_C)		30 Seconds
Average ramp-down rate (T_P to T_{smax})		6°C / Second Max.
Time (25°C to Peak Temperature)		8 Minutes Max.

Temperature Derating Curve

Normal ambient temperature: 23+/-3°C

Operating temperature: -55 ~ 125°C, with proper correction factor applied



Package

3000 fuses on 8mm tape-and-reel on a 7 inch (178mm) reel per EIA Standard 481.

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